

FQD16N25C 250V N-Channel MOSFET

Features

- * 16A, 250V, $R_{DS(on)}$ = 0.27 Ω @V_{GS} = 10 V * Low gate charge (typical 41 nC)
- Low Crss (typical 68 pF)
- · Fast switching
- 100% avalanche tested
- · Improved dv/dt capability
- RoHS compliant



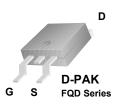


Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supplies, DC-AC converters for uninterrupted power supplies and motor controls.

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Absolute Maximum Ratings

Symbol	Parameter		FQD16N25C	Units
V _{DSS}	Drain-Source Voltage		250	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		16	А
	- Continuous (T _C = 100°C)		10.1	А
I _{DM}	Drain Current - Pulsed	(Note 1)	64	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	432	mJ
I _{AR}	Avalanche Current	(Note 1)	16	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	160	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
P _D	Power Dissipation ($T_C = 25^{\circ}C$)		160	W
	- Derate above 25°C		1.28	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FQD16N25C	Units	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.78	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient	110	°C/W	

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Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FQD16N25C	FQD16N25CTM	D-PAK	380mm	16mm	2,500
FQD16N25C	FQD16N25CTF	D-PAK	380mm	16mm	2,000

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Charac	teristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	250			V
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		0.31		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 250 V, V_{GS} = 0 V			10	μA
		V_{DS} = 200 V, T_{C} = 125°C			100	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 30 V, V_{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0 V			-100	nA
On Charact	teristics					
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 8A		0.22	0.27	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D =8 A (Note 4)		10.5		S
Dynamic Cl	haracteristics					
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V,		830	1080	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		170	220	pF
C _{rss}	Reverse Transfer Capacitance			68	89	pF
Switching C	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 125 V, I _D = 16A,		15	40	ns
t _r	Turn-On Rise Time	R _G = 25 Ω		130	270	ns
t _{d(off)}	Turn-Off Delay Time	-		135	280	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		105	220	ns
Qg	Total Gate Charge	V _{DS} = 200 V, I _D = 16A,		41	53.5	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		5.6		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		22.7		nC
Drain-Sour	ce Diode Characteristics and Maximum Ratings	5				
I _S	Maximum Continuous Drain-Source Diode Fo	rward Current			16	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				64	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 16 A			1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 16 A,		260		ns
Q _{rr}	Reverse Recovery Charge	$dI_{F}/dt = 100 \text{ A}/\mu \text{s}$ (Note 4)		2.47		μC

NOTES:

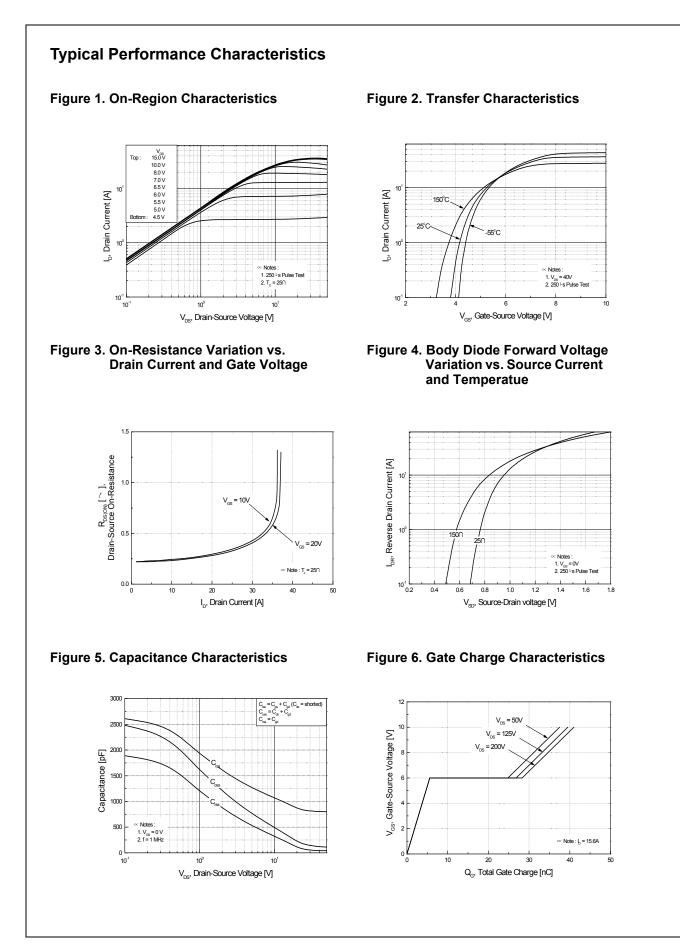
1. Repetitive Rating : Pulse width limited by maximum junction temperature

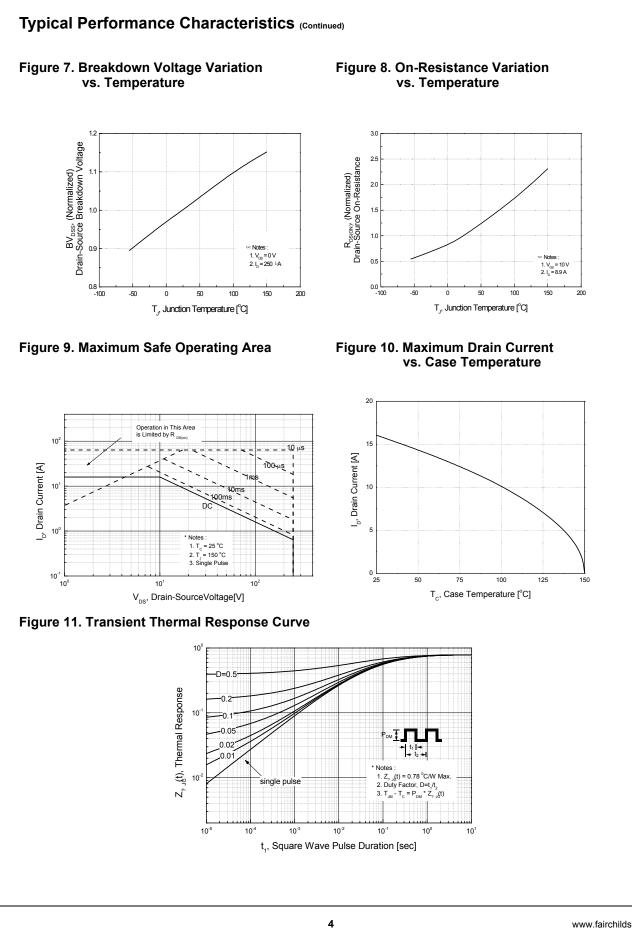
2. L = 2.7mH, I_{AS} = 16A, V_{DD} = 50V, R_G = 25 $\Omega,$ Starting T_J = 25°C

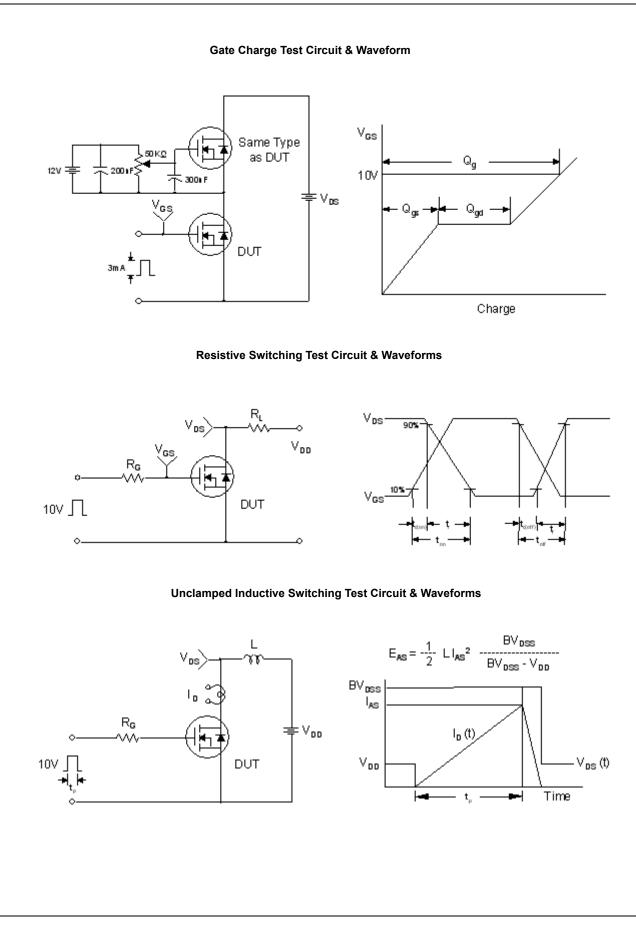
3. I_{SD} \leq 16A, di/dt \leq 300A/µs, V_{DD} \leq BV_{DSS,} Starting ~T_J = 25°C

4. Pulse Test : Pulse width $\leq 300 \mu s,$ Duty cycle $\leq 2\%$

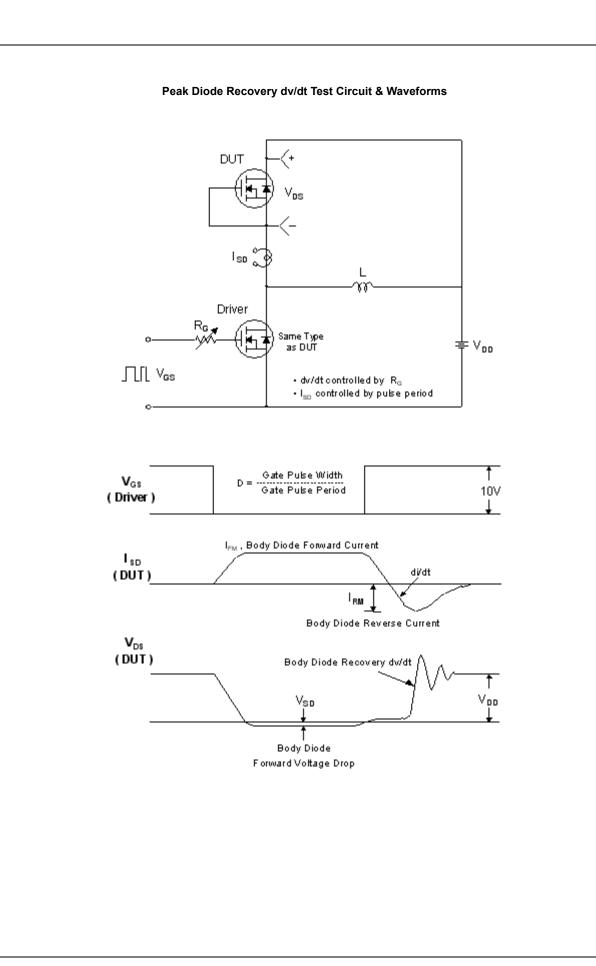
5. Essentially independent of operating temperature

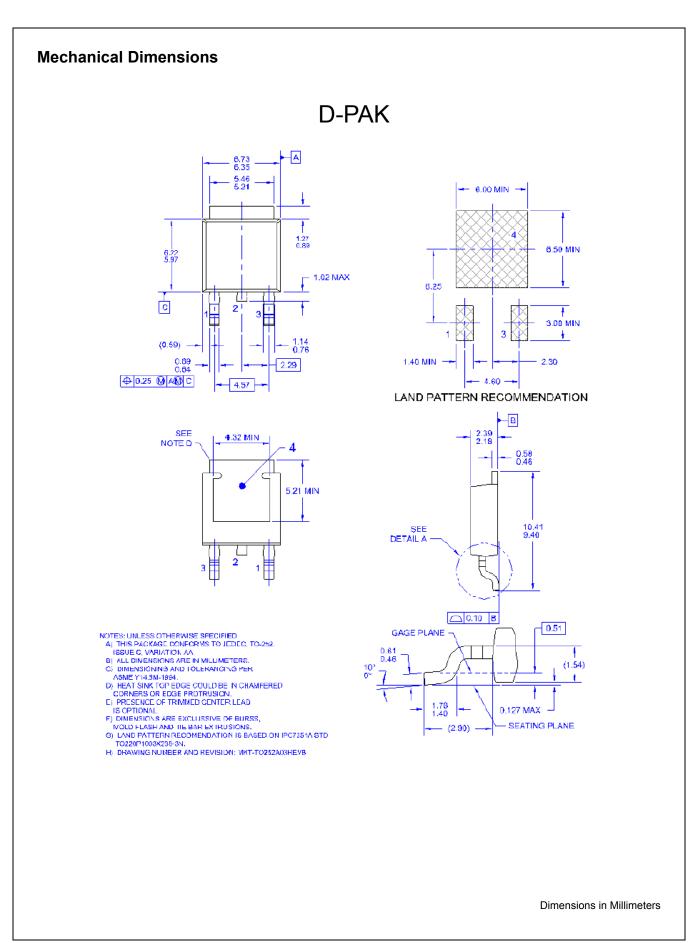






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